PWM Output Temperature Sensors in SC70 Packages

Absolute Maximum Ratings

Supply Voltage (V _{CC} to GND)	0.3V to +6V
DOUT to GND (MAX6672)	0.3V to +6V
DOUT to GND (MAX6673)	0.3V to (V _{CC} + 0.3V)
DOUT Short to GND	Continuous
ESD Protection (Human Body Model)	±2000V
Continuous Power Dissipation ($T_A = +70$)°C)
5-Pin SC70 (derate 2.5mW/°C above	+70°C)200mW

Operating Temperature Range	40°C to +125°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C
SC70 Package	
Vapor Phase (60s)	+215°C
Infrared (15s)	+220°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

(V_{CC} = 2.4V to 5.5V, T_A = -40°C to +125°C, unless otherwise noted. Typical values specified at +25°C and V_{CC} of 3.3V.) (Note 1)

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS
			T _A = +25°C to +100°C	-3		+3	
Temperature Error			T _A = 0°C to +125°C	-4		+4	°C
(Note 2)		V _{CC} = 3.3V	T _A = -20°C to +125°C	-5		+5	
			$T_A = -40^{\circ}C$ to $-20^{\circ}C$		±3		
Nominal t ₁ Pulse Width					280		μs
Output Low Voltage	V _{OL}	I _{SINK} = 3mA				0.4	V
Output High Voltage	V _{OH}	I _{SOURCE} = 8	00µA (MAX6673)	V _{CC} - 0.5			V
Fall Time	t _{FALL}	C _{LOAD} = 100	pF		14		ns
Rise Time	t _{RISE}	C _{LOAD} = 100	pF (MAX6673)		96		ns
DOUT Open-Drain Leakage Current		V _{DOUT} = 6V	(MAX6672)		0.1		μA
Output Capacitance					2.5		pF
Power-Supply Rejection Ratio	PSRR	2.4V to 5.5V,	T _A = -25°C to +125°C		0.3	0.8	°C/V
Supply Current		2.4V to 3.6V			60	100	
Supply Current	Icc	3.6V to 5.5V			70	150	μA

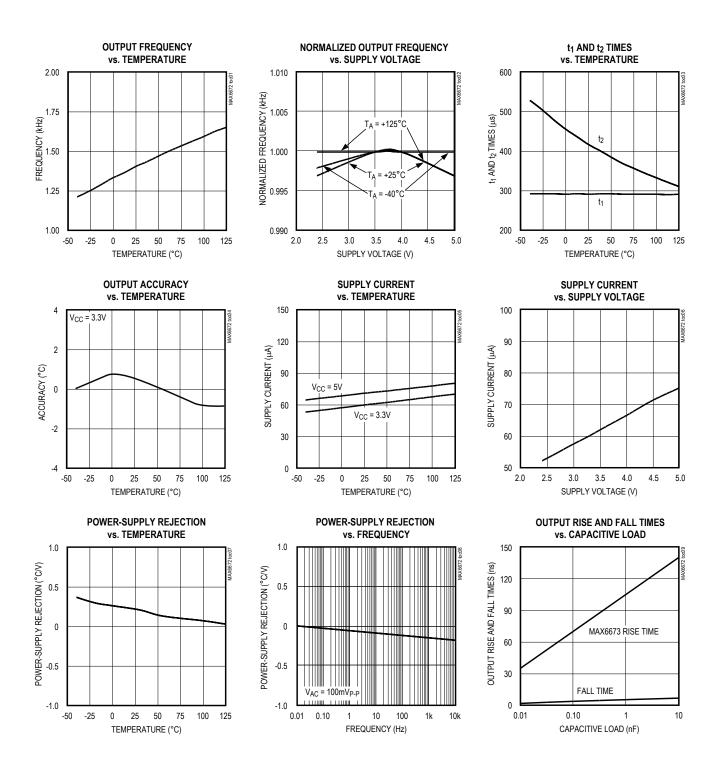
Note 1: All specifications are 100% tested at $T_A = +25^{\circ}C$. Specification limits over temperature ($T_A = -40^{\circ}C$ to $+125^{\circ}C$) are guaranteed by design, not production tested.

Note 2: Temperature = $-200 \times (0.85 - T_1/T_2)^3 + (425 5 T_1/T_2) - 273$. T₁ is the low time period. T₂ is the high time period (Figure 1).

PWM Output Temperature Sensors in SC70 Packages

Typical Operating Characteristics

(V_{CC} = 3.3V, T_A = $+25^{\circ}$ C, unless otherwise noted.)

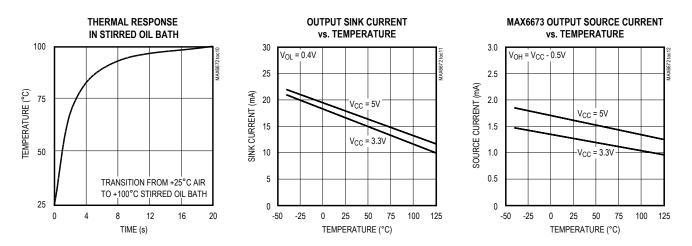


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PWM Output Temperature Sensors in SC70 Packages

Typical Operating Characteristics (continued)

(V_{CC} = 3.3V, T_A = $+25^{\circ}$ C, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION		
1	DOUT	Digital Output Pin. PWM output, open-drain output (MAX6672), or push-pull output (MAX6673).		
2	N.C.	No Connection. Not internally connected.		
3, 4	GND	Pin 3 and Pin 4 must be tied together and connected to ground.		
5	V _{CC}	Positive Supply. Bypass with a 0.1µF capacitor to GND.		

Detailed Description

The MAX6672/MAX6673 are low-current (60µA, typ), local temperature sensors ideal for interfacing with µCs or µPs. The MAX6672/MAX6673 convert their own temperature into a ratiometric PWM output. The square-wave output waveform time ratio contains the temperature information. The output is a square wave with a nominal frequency of 1.4kHz at +25°C. The temperature is obtained with the following formula:

Temperature (°C) = -200 x $(0.85 - t_1 / t_2)^3$ + (425 x t_1 / t_2) - 273

Where t_1 is a fixed value and t_2 is modulated with the temperature. Table 1 lists time ratio vs. temperature.

For temperatures greater than +50°C, the temperature error is primarily first order and the following equation can be used:

Temperature (°C) = $(425 \times t_1 / t_2) - 273$

The MAX6673 has a push-pull output. The rise and fall times of the MAX6673 output are negligible with respect to the period; therefore, errors caused by capacitive loading are minimized.

The output load capacitance should be minimized in MAX6672 applications because the sourcing current is set by the pullup resistor. If the output capacitance becomes too large, unequal rise and fall times distort the pulse width, thus delivering inaccurate readings.

Applications Information

Pulse-Width Modulation

Interfacing with a µC

The *Typical Application Circuit* shows the MAX6672/ MAX6673 interfaced with a μ C. In this example, the MAX6672/MAX6673 convert the ambient temperature to a PWM waveform. The μ C reads the temperature by measuring the t₁ and t₂ periods in software and hardware. The only timing requirements are that the clock frequency used for timing measurements is stable and

PWM Output Temperature Sensors in SC70 Packages

TIME RATIO (t ₁ /t ₂)	TEMPERATURE (°C)
0.936	125
0.878	100
0.807	70
0.714	30
0.646	0
0.602	-25
0.560	-40

Table 1. Time Ratio vs. Temperature

high enough to provide the required measurement resolution. The interface for the MAX6672 requires a pullup resistor.

Thermal Response Time

The time periods t_1 (low) and t_2 (high) are values that are easily read by the μ P timer/counter. The temperature reading is then calculated using software. Since both periods are obtained consecutively, using the same clock, performing the division indicated in the above formulae results in a ratiometric value that is independent of the exact frequency.

Sensing Circuit Board and Ambient Temperatures

Temperature sensor ICs such as the MAX6672/ MAX6673 that sense their own die temperatures must be mounted on or close to the object whose temperature they are intended to measure. Because there is a good thermal path between the SC70 package's metal leads and the IC die, the MAX6672/MAX6673 can accurately measure the temperature of the circuit board to which they are soldered. If the sensor is intended to measure the temperature of a heat-generating component on the circuit board, it should be mounted as close as possible to that component and should share supply and ground traces (if they are not noisy) with that component where possible. This maximizes the heat transfer from the component to the sensor.

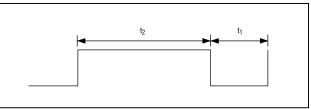
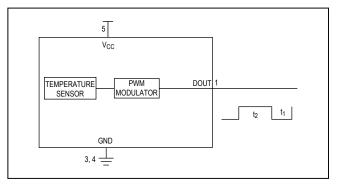


Figure 1. PWM Waveform Timing

Block Diagram



The thermal path between the plastic package and the die is not as good as the path through the leads, so the MAX6672/MAX6673, like all temperature sensors in plastic packages, are less sensitive to the temperature of the surrounding air than they are to the temperature of their leads. They can be successfully used to sense ambient temperature if the circuit board is designed to track the ambient temperature.

As with any IC, the wiring and circuits must be kept insulated and dry to avoid leakage and corrosion, especially if the part is operated at cold temperatures where condensation can occur.

The error caused by power dissipation in the MAX6672/ MAX6673 is negligible.

Chip Information PROCESS: BiCMOS

PWM Output Temperature Sensors in SC70 Packages

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.	LAND PATTERN NO.
5 SC70	X5-1	<u>21-0076</u>	<u>90-0188</u>

PWM Output Temperature Sensors in SC70 Packages

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/02	Initial release	—
1	4/14	Removed automotive reference from Applications	1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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